TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOSII)

TPC6001

Notebook PC Applications Portable Equipment Applications

- Low drain-source ON resistance: R_{DS} (ON) = 22 m Ω (typ.)
- High forward transfer admittance: $|\,Y_{\rm fs}\,|$ = 15 S (typ.)
- Low leakage current: $IDSS = 10 \ \mu A \ (max) \ (VDS = 20 \ V)$
- Enhancement-model: V_{th} = 0.5 to 1.2 V (V_{DS} = 10 V, I_D = 200 μA)

Maximum Ratings (Ta = 25°C)

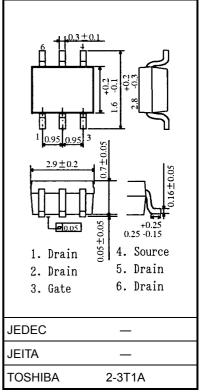
Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	20	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V _{DGR}	20	V	
Gate-source voltage		V _{GSS}	±12	V	
Drain current	DC (Note 1)	Ι _D	6	А	
	Pulse (Note 1)	I _{DP}	24	A	
Drain power dissipation	(t = 5 s) (Note 2a)	PD	2.2	W	
Drain power dissipation	(t = 5 s) (Note 2b)	PD	0.7	W	
Single pulse avalanche ene	E _{AS}	5.8	mJ		
Avalanche current	I _{AR}	3	А		
Repetitive avalanche energy (Note 4)		E _{AR}	0.22	mJ	
Channel temperature	T _{ch}	150	°C		
Storage temperature range	T _{stg}	-55 to 150	°C		

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient $(t = 5 s)$ (Note 2a)	R _{th (ch-a)}	56.8	°C/W
Thermal resistance, channel to ambient (t = 5 s) (Note 2b)	R _{th (ch-a)}	178.5	°C/W

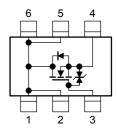
Note: (Note 1), (Note 2), (Note 3), (Note 4), (Note 5) Please see next page.

This transistor is an electrostatically sensitive device. Please handle it with caution.

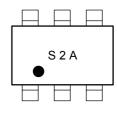


Weight: 0.011 g (typ.)

Circuit Configuration



Marking (Note 5)



Unit: mm

Electrical Characteristics (Ta = 25°C)

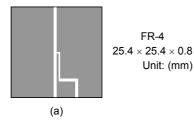
Cha	aracteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS}=\pm 10~V,~V_{DS}=0~V$			±10	μA
Drain cut-OFF cu	irrent	I _{DSS}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			10	μA
Drain-source breakdown voltage		V (BR) DSS	$I_{D} = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	20	_	_	V
		V (BR) DSX	$I_D = 10 \text{ mA}, V_{GS} = -12 \text{ V}$	8	_	_	v
Gate threshold ve	oltage	V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 200 \mu\text{A}$	0.5		1.2	V
		R _{DS (ON)}	$V_{GS} = 2.0 \text{ V}, \text{ I}_{D} = 3 \text{ A}$		35	60	
Drain-source ON	resistance	R _{DS (ON)}	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 3 \text{ A}$		28	45	mΩ
		R _{DS (ON)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 3 \text{ A}$		22	30	
Forward transfer	admittance	Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}$	7.5	15	_	S
Input capacitance		C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		755	_	pF
Reverse transfer capacitance		C _{rss}			172	_	
Output capacitance		C _{oss}			222	_	
Switching time	Rise time	tr	$V_{GS} \stackrel{5}{\overset{0}{\overset{0}{\overset{0}{\overset{0}{\overset{0}{\overset{0}{\overset{0}{\overset$	_	6		
	Turn-ON time	t _{on}			11	_	- ns
	Fall time	t _f		_	32		
	Turn-OFF time	t _{off}	$V_{DD}\simeq 10~V \label{eq:VDD}$ Duty $\leq 1\%,~t_W=10~\mu s$	_	64	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD}\simeq 16~V,~V_{GS}=5~V,~I_{D}=6~A$	_	15	_	
Gate-source charge		Q _{gs}			10		nC
Gate-drain ("miller") charge		Q _{gd}			5		

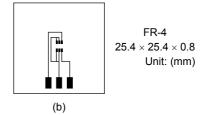
Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Pulse drain reverse current	(Note 1)	I _{DRP}	—	_		24	А
Forward voltage (diode)		V _{DSF}	$I_{DR} = 6 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.2	V

Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (a)

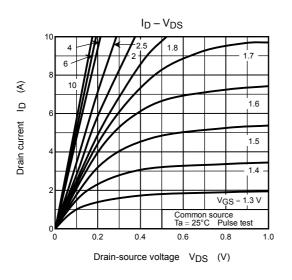


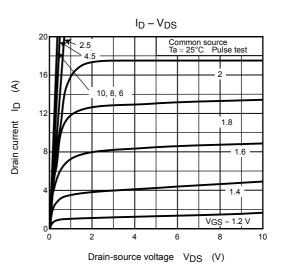


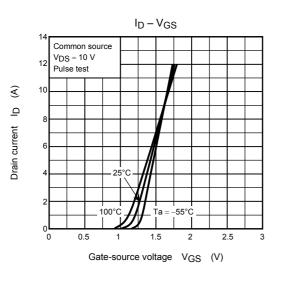
(b) Device mounted on a glass-epoxy board (b)

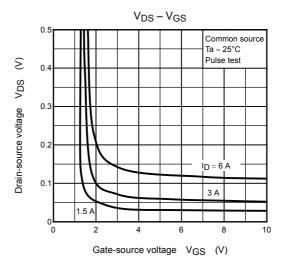
- Note 3: V_{DD} = 16 V, T_{ch} = 25°C (initial), L = 0.5 mH, R_G = 25 Ω , I_{AR} = 3.0 A
- Note 4: Repetitive rating; pulse width limited by maximum channel temperature
- Note 5: Black round marking "•" locates on the left lower side of parts number marking "S2A" indicates terminal No.1.

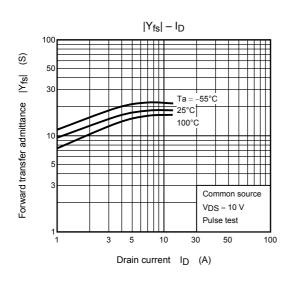
TOSHIBA



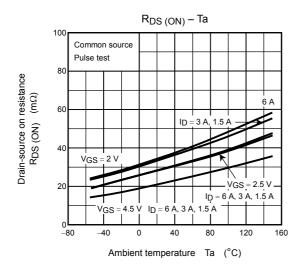


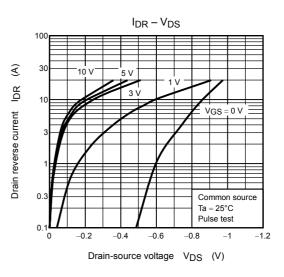


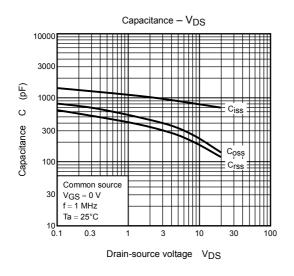


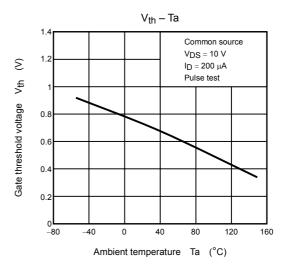


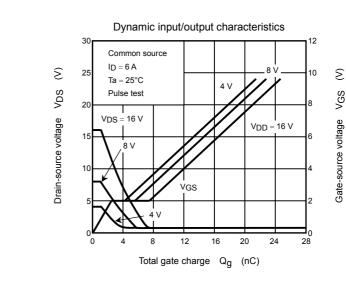
R_{DS} (ON) - I_D 100 -2 V Drain-source on resistance RDS (ON) $(m\Omega)$ 2.5 V 30 4.5 V VGS = 10 Common source $T_a = 25^{\circ}C$ Pulse test 1 0.1 0.3 1 3 10 30 100 Drain current ID (A)

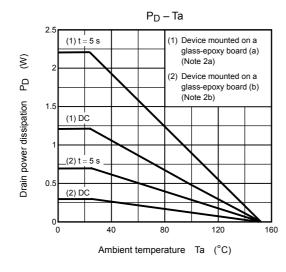


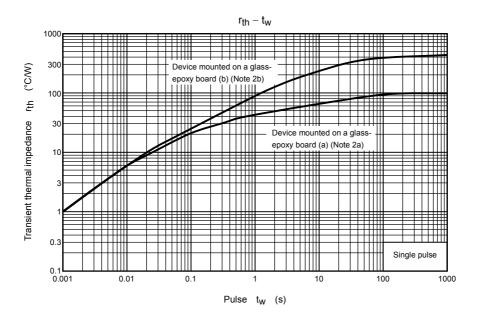




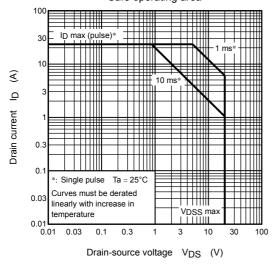








Safe operating area



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Handbook" etc.,

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